

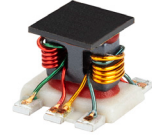


Directional Coupler **TCD-16-12W-75X+**

75Ω 16.5dB 5 to 1218 MHz

FEATURES

- Wideband, 5 to 1218 MHz
- Low mainline loss, 0.7 dB typ.
- Aqueous washable
- Leads for excellent solderability
- Protected by US Patent 6,140,887



Generic photo used for illustration purposes only

CASE STYLE: DB1627

APPLICATIONS

- DOCSIS® Systems
- VHF/UHF
- CATV
- Cellular

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range	—	5	—	1218	MHz
Mainline Loss ¹ (above theoretical 0.1 dB)	5-50	—	0.65	0.9	dB
	50-870	—	0.5	0.8	
	870-1218	—	0.70	1.0	
Coupling	5-1218	—	16.0±0.5	—	dB
Coupling Flatness (±)	5-1218	—	±0.8	±1.2	dB
Directivity	5-50	25	35	—	dB
	50-870	11	16	—	
	870-1218	8	12	—	
Return Loss (Input)	5-50	18	22	—	dB
	50-870	14	18	—	
	870-1218	16	19	—	
Return Loss (Output)	5-50	20	25	—	dB
	50-870	17	19	—	
	870-1218	18	22	—	
Return Loss (Coupling)	5-50	18	22	—	dB
	50-870	15	17	—	
	870-1218	14	16	—	
Input Power	5-1218	—	—	1.0	W

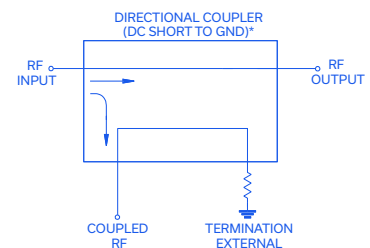
1. Mainline loss includes theoretical power loss at coupled port.

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C*
Storage Temperature	-55°C to 100°C

Permanent damage may occur if any of these limits are exceeded.
* Case temperature is defined as temperature on ground leads.

ELECTRICAL SCHEMATIC



*Electrical schematic is for Directional coupler with internal transformer(s) and external termination

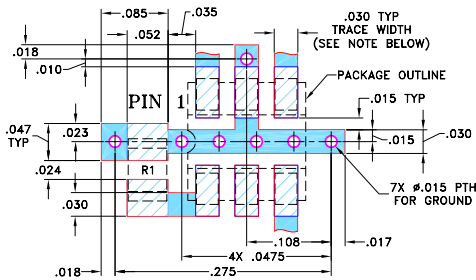


PIN CONNECTIONS

INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
75Ω TERM EXTERNAL	6
NOT USED	5

PRODUCT MARKING: UR

**DEMO BOARD MCL P/N: TB-72
SUGGESTED PCB LAYOUT (PL-010)**



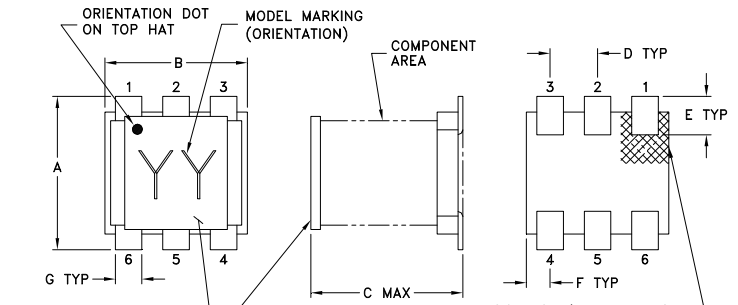
RESISTOR R1: 75 ± 1% Ohm, 0805 SIZE

NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

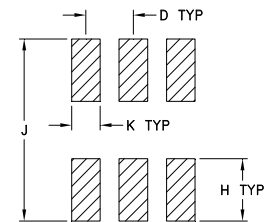
OUTLINE DRAWING



TOP-HAT / PICK & PLACE SURFACE AREA (10X.10) MIN
TOP-HAT TOTAL THICKNESS: .013 inches MAX.

Orientation dot on Top-Hat & orientation feature on substrate corresponds to pin #1.

PCB Land Pattern



SUGGESTED LAYOUT TOLERANCE TO BE WITHIN ±.002

OUTLINE DIMENSIONS (Inches mm)

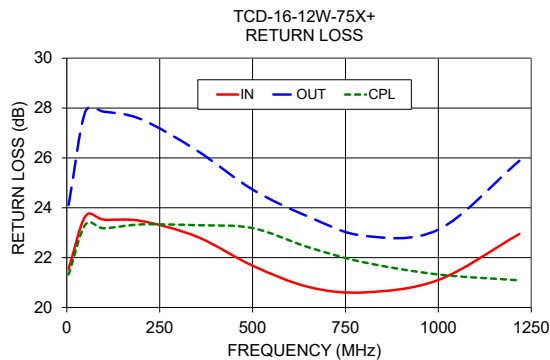
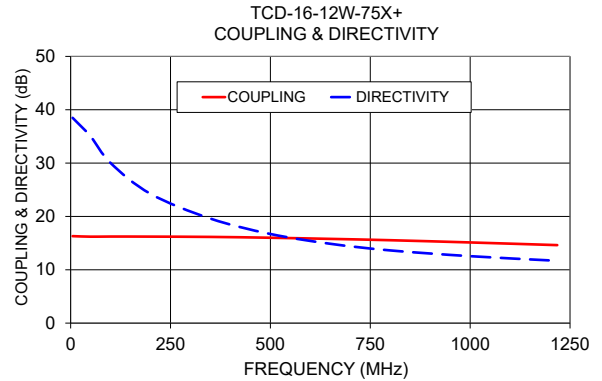
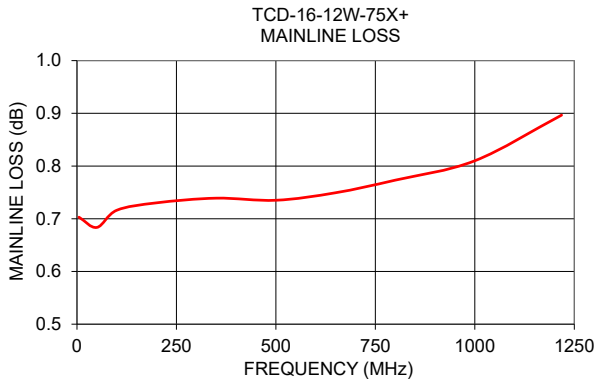
A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.15

TAPE & REEL INFORMATION: F47



TYPICAL PERFORMANCE DATA

Frequency (MHz)	Mainline Loss (dB)	Coupling (dB)	Directivity (dB)	Return Loss (dB)		
	In-Out			In	Out	Cpl
5	0.70	16.30	38.48	21.56	24.12	21.32
50	0.68	16.20	34.99	23.66	27.86	23.32
100	0.72	16.23	30.01	23.52	27.85	23.18
200	0.73	16.21	24.23	23.47	27.55	23.33
350	0.74	16.16	19.59	22.84	26.30	23.30
500	0.74	16.00	16.71	21.68	24.73	23.18
650	0.75	15.79	14.87	20.83	23.65	22.42
800	0.77	15.54	13.63	20.61	22.88	21.81
1000	0.81	15.12	12.55	21.11	23.12	21.32
1218	0.90	14.62	11.68	22.95	25.89	21.09



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Directional Coupler

TCD-16-12W-75X+

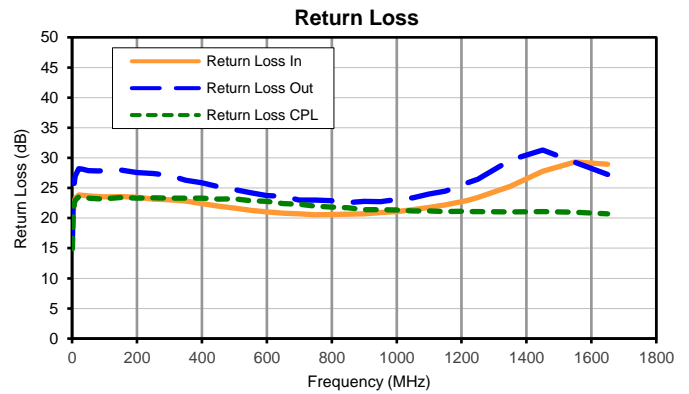
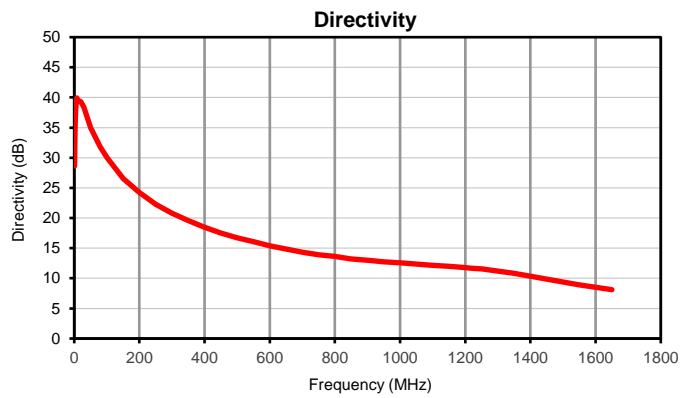
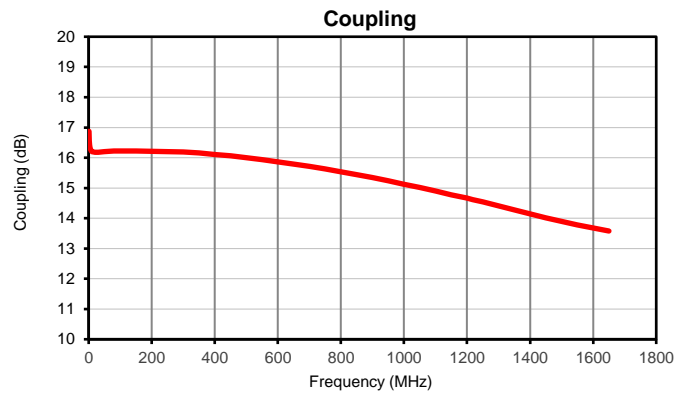
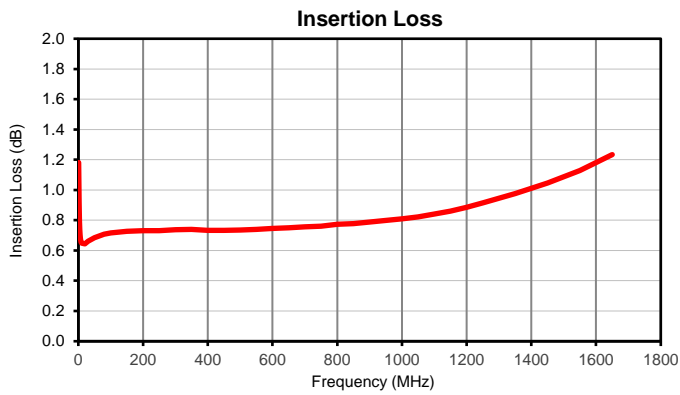
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS (dB)		
				IN	OUT	CPL
1	1.18	16.87	28.62	15.12	16.03	14.89
2	0.92	16.56	33.71	17.96	19.33	17.75
3	0.80	16.42	36.16	19.67	21.48	19.45
4	0.74	16.35	37.52	20.79	23.00	20.56
5	0.70	16.30	38.48	21.56	24.12	21.32
6	0.68	16.28	39.17	22.13	25.02	21.89
8	0.65	16.23	39.92	22.84	26.25	22.59
10	0.65	16.20	39.55	23.25	26.99	22.97
20	0.64	16.18	39.34	23.82	28.19	23.53
30	0.66	16.18	38.36	23.78	28.12	23.48
50	0.68	16.20	34.99	23.66	27.86	23.32
80	0.71	16.22	31.80	23.56	27.80	23.20
100	0.72	16.23	30.01	23.52	27.85	23.18
150	0.73	16.22	26.51	23.60	27.98	23.40
200	0.73	16.21	24.23	23.47	27.55	23.33
250	0.73	16.20	22.30	23.17	27.39	23.36
300	0.74	16.19	20.79	23.06	27.08	23.32
350	0.74	16.16	19.59	22.84	26.30	23.30
400	0.73	16.10	18.47	22.39	25.85	23.30
450	0.73	16.06	17.52	22.01	25.21	23.17
500	0.74	16.00	16.71	21.68	24.73	23.18
550	0.74	15.94	16.08	21.31	24.20	22.90
600	0.74	15.87	15.38	21.04	23.74	22.79
650	0.75	15.79	14.87	20.83	23.65	22.42
700	0.76	15.72	14.32	20.70	22.97	22.32
750	0.76	15.63	13.91	20.57	22.97	22.01
800	0.77	15.54	13.63	20.61	22.88	21.81
850	0.78	15.44	13.23	20.67	22.55	21.71
900	0.79	15.34	13.02	20.71	22.80	21.42
950	0.80	15.24	12.72	20.92	22.72	21.40
1000	0.81	15.12	12.55	21.11	23.12	21.32
1050	0.82	15.01	12.35	21.42	23.37	21.20
1100	0.84	14.90	12.15	21.76	24.01	21.17
1150	0.86	14.78	12.01	22.19	24.47	21.08
1200	0.89	14.67	11.77	22.72	25.48	21.11
1218	0.90	14.62	11.68	22.95	25.89	21.09
1250	0.92	14.54	11.57	23.43	26.46	21.06
1350	0.98	14.28	10.84	25.28	29.63	21.04
1450	1.05	14.01	9.89	27.76	31.30	21.07
1550	1.13	13.78	8.92	29.31	29.25	20.97
1650	1.23	13.58	8.11	28.95	27.23	20.70

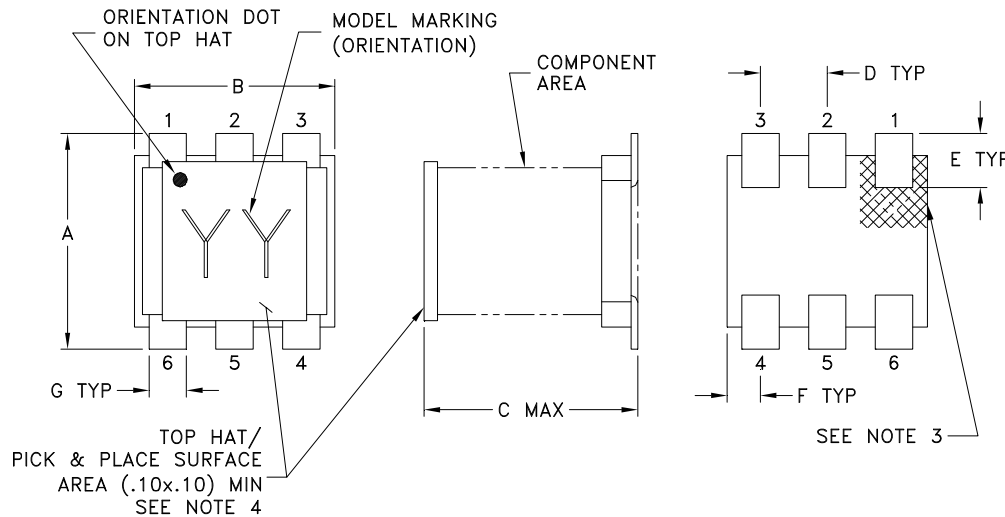
Directional Coupler

TCD-16-12W-75X+

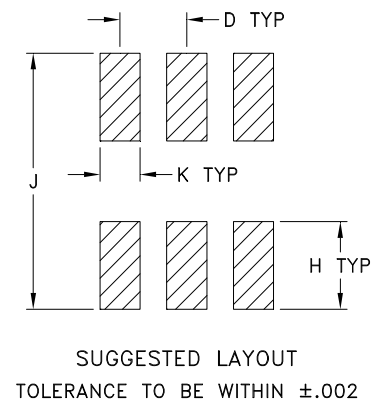
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB1627	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

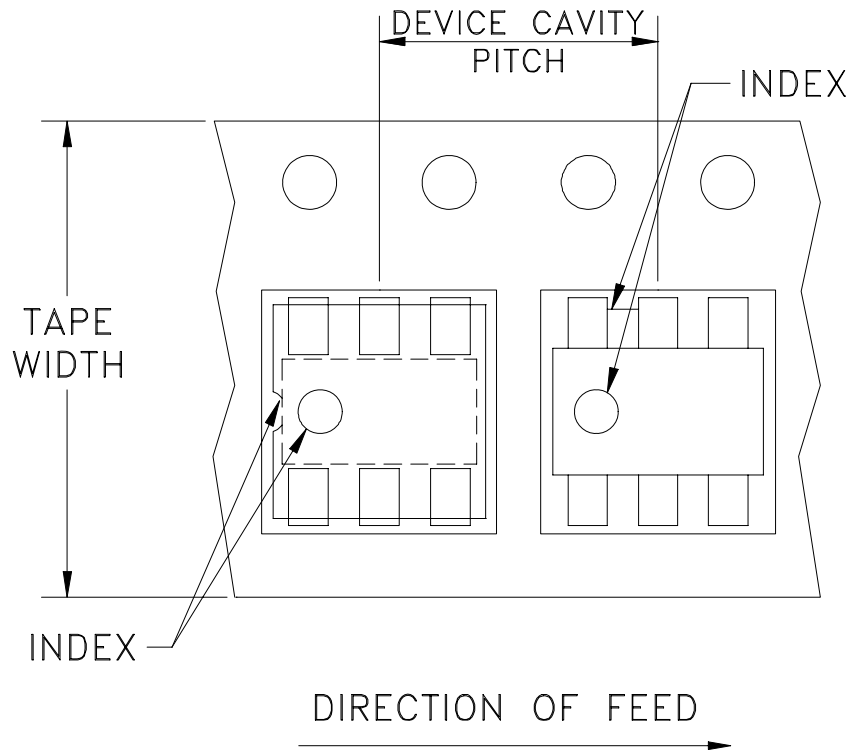
Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Orientation dot on top hat & orientation feature on substrate correspondence to pin #1.
- Top-Hat total thickness: .013 inches MAX.

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

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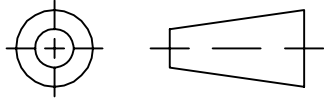
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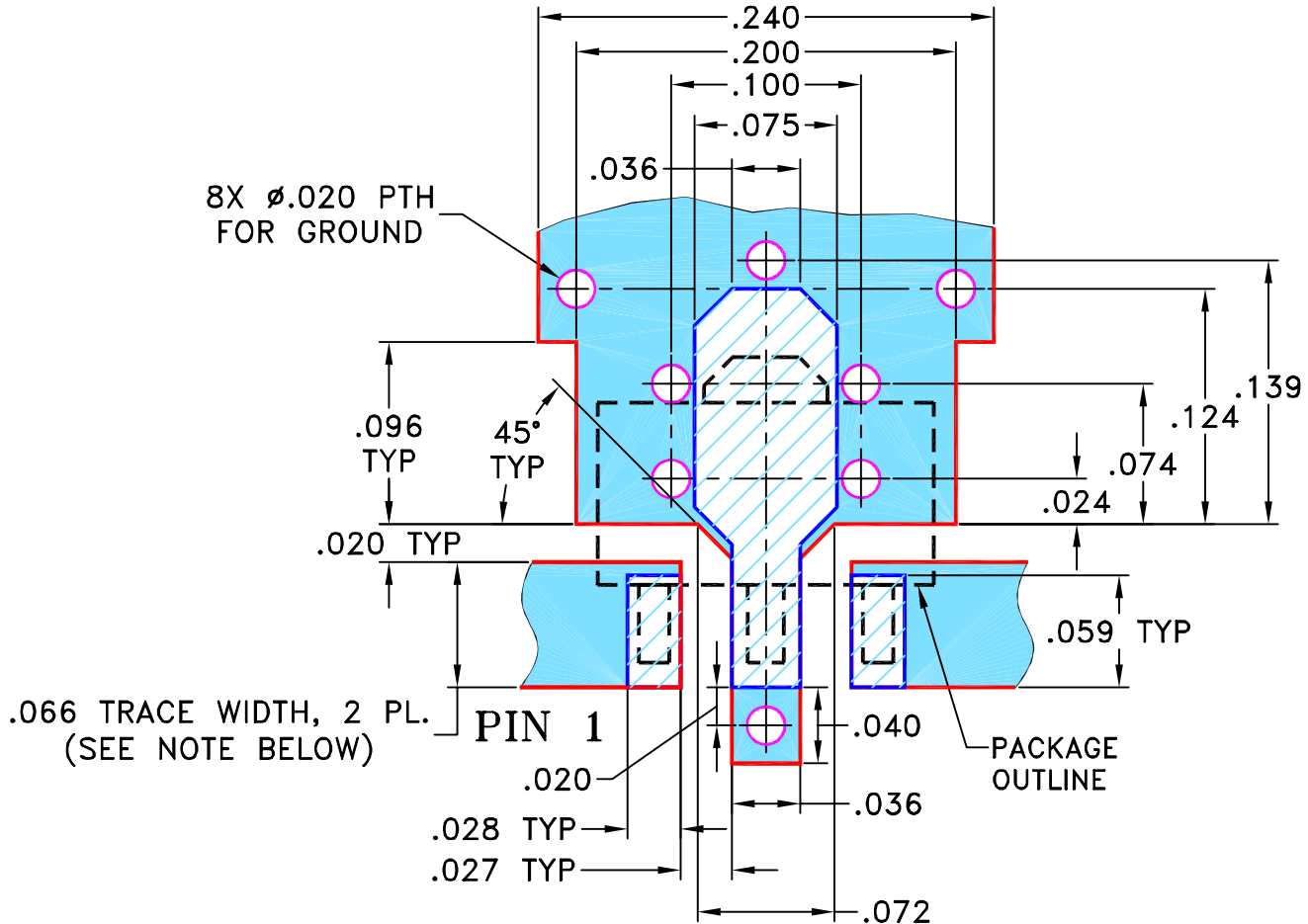
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M76190	CHANGED DISCRIPTION	04/01	GF	CT
B	M82575	UPDATED DRAWING	08/05/02	AV	LC
C	M102713	ADDED NOTE 2 & "...WITH SMOBC"	01/17/06	MMG	IL
D	M108434	UPDATED DRAWING PER TB-409+	11/14/06	PW	IG

SUGGESTED MOUNTING CONFIGURATION
FOR DF782 CASE STYLE, "mz" PIN CONNECTION



- NOTES:** 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	AV 01/15/01
	CHECKED	YB 01/23/01
	APPROVED	DB 01/23/01



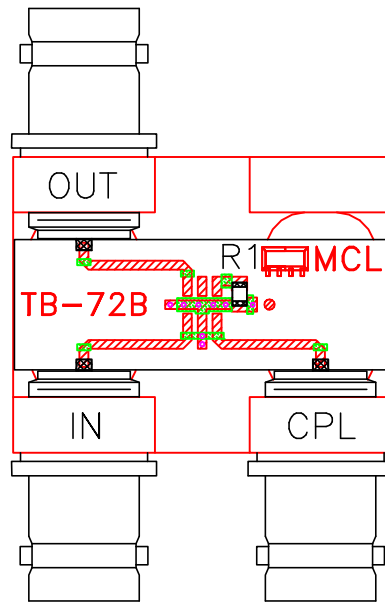
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Brooklyn NY 11235

PL, mz, DF782, GALI, TB-409-XXX+

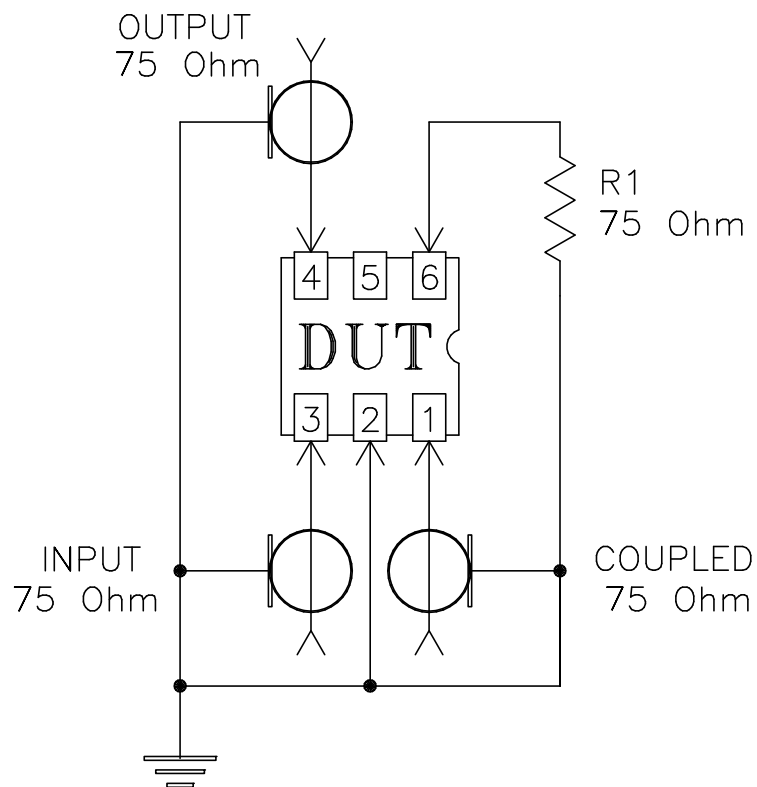
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SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-019	D
FILE:	98PL019	SCALE: 10:1	SHEET: 1 OF 1

Evaluation Board and Circuit




TB-72



Schematic Diagram

Notes:

1. 75 Ohm BNC Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215